

Title (en)
Hybrid integrated circuit device.

Title (de)
Hybridschaltungsanordnung.

Title (fr)
Dispositif à circuit intégré hybride.

Publication
EP 0665560 A3 19970502 (DE)

Application
EP 94119166 A 19941205

Priority
DE 9319473 U 19931217

Abstract (en)
[origin: US5581227A] A hybrid circuit unit having a film resistor on a circuit carrier and a ceramic stripe having an area of at least approximately the same size as the film resistor is secured in a highly thermally conductive way to at least one side of the plate-shaped circuit carrier.

IPC 1-7
H01C 1/084

IPC 8 full level
H01C 1/01 (2006.01); **H01C 1/084** (2006.01); **H01C 1/144** (2006.01); **H01L 23/498** (2006.01)

CPC (source: EP US)
H01C 1/01 (2013.01 - EP US); **H01C 1/084** (2013.01 - EP US); **H01L 2924/0002** (2013.01 - EP US)

Citation (search report)

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US5914648A; US6253446B1

Designated contracting state (EPC)
AT CH DE FR GB IT LI SE

DOCDB simple family (publication)
US 5581227 A 19961203; AT E191581 T1 20000415; DE 59409274 D1 20000511; DE 9319473 U1 19940623; EP 0665560 A2 19950802; EP 0665560 A3 19970502; EP 0665560 B1 20000405

DOCDB simple family (application)
US 24220094 A 19940513; AT 94119166 T 19941205; DE 59409274 T 19941205; DE 9319473 U 19931217; EP 94119166 A 19941205